10/696,598.

PTO/SB/21 (09-04) (AW 10/2004)

Approved for use through 7/31/2006. OMB 0651-0031
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# TRANSMITTAL FORM

(to be used for all correspondence after initial filing)

Total Number of Pages in This Submission

U.S. Patent No.	6,983,538 B2	
Issued	January 10, 2006	
First Named Inventor	Masafumi Inoue et al.	
Art Unit		
Examiner Name		
Attorney Docket No.	MAT-8184US1	

ENCLOSURES (Check all that apply)					
Fee Transmittal Form Fee Attached	Drawing(s)  Licensing-related Papers	After Allowance Communication to TC			
Amendment/Reply After Final	Petition to Convert to a	Appeal Communication to Board of Appeals and Interferences  Appeal Communication to TC			
Affidavits/Declaration(s)	Provisional Application	(Appeal Notice, Brief, Reply Brief)			
Extension of Time Request	Power of Attorney, Revocation, Change of Correspondence Address	Proprietary Information			
Express Abandonment Request	Terminal Disclaimer	Status Letter  Other Enclosure(s) (please			
Information Disclosure Statement	Request for Refund	identify below):			
Certified Copy of Priority Document(s)	CD, Number of CD(s)  Landscape Table on CD	Request for Certificate of Correction PTO Form 1050 Return Postcard			
Response to Missing Parts/ Incomplete Application		Certificate			
Response to Missing Parts under 37 CFR 1.52 or 1.53	Remarks:	Certificate  MAR 3 1 2006  of Correction			
Of Corner!					
SIGNATURE OF APPLICANT, ATTORNEY OR AGENT					
Firm Name RatnerPrestia					
Signature Pleneum ( Chry					
Printed Name Lawrence E. Ashery					
Date   March 27, 2006   Registration No. 34,515					
CERTIFICATE OF TRANSMISSION / MAILING					
I hereby certify that this correspondence is being facsimile transpirited to the USPTO or deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on the date shown below:					
Signature Debort Coratt					
Typed or Printed Name Deborah Spratt Date March 27, 2006					

This collection of information is required by 37 CFR 1.5. The information is required to obtain or retain a benefit by the public which is to file (and by the USPTO to process) an application. Confidentiality is governed by 35 U.S.C. 122 and 37 CFR 1.11 and 1.14. This collection is estimated to take 2 hours to complete, including gathering, preparing, and submitting the completed application form to the USPTO. Time will vary depending upon the individual case. Any comments on the amount of time you require to complete this form and/or suggestions for reducing this burden, should be sent to the Chief Information Office, U.S. Patent and Trademark Office, U.S. Department of Commerce, P.O. Box 1450, Alexandria, VA 22313-1450. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Commissioner for Patents, P.O. Box 1450, ALEXANDRIA, VA 22313-1450.

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MAR 29 JOHR

### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent Number:

6,983,538 B2

Name of Patentee:

January 10, 2006 Masafumi Inoue et al.

Title of Invention:

METHOD OF MOUNTING COMPONENT ON A CIRCUIT BOARD

## REQUEST FOR CERTIFICATE OF CORRECTION OF PATENT FOR PTO MISTAKE (37 C.F.R. § 1.322(a))

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Attention:

**Decision and Certificate of Correction** 

Branch of the Patent Issue Division

- 1. Attached in duplicate is Form PTO-1050 with at least one copy being suitable for printing.
- 2. Correction of the Official Letters Patent is respectfully requested in view of the following text which appears correctly in the application file:

Column 6, lines 21-49, claims 4-7, delete

- "4. A method of mounting components on a board, said method comprising the steps of:
  - a) receiving mounting locations of where said components are intended to be mounted on said board,
  - b) determining where solder for said components is situated on said board,
  - c) determining where said components are to be mounted on said board based on steps a) and b); and
  - d) mounting said components on said board based on step c).
- 5. A method of mounting components according to claim 4, wherein step c) includes the step of modifying said mounting locations based on step b), wherein said components are mounted in step d) based on said modified mounting locations.
  - 6. Apparatus for mounting components on a board, comprising:
  - a memory in which is situated location values which correspond to where components are intended to be mounted on said board;
  - a locator for identifying solder locations which correspond to respective locations of solder on said board;
  - a mounter for mounting said components based on said location values and said solder locations.

7. Apparatus for mounting components according to claim 6, further comprising a calculation unit which modifies said location values based on said solder values, wherein said mounter mounts said components based on said modified location values."

as written in the Supplemental Preliminary Amendment dated October 29, 2003, page 3, line 33, claims 9-12. Amendment claims 9-12 are Patent claims 4-7.

3. Please send the Certificate to:

Name:

Lawrence E. Ashery

P.O. Box 980

Valley Forge, PA 19482

(610) 407-0700

Name of Assignee:

Matsushita Electric Industrial Co., Ltd.

Assignment Recorded on:

January 4, 2002

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Enclosure: Form PTO-1050 (in duplicate)

Dated:

March 27, 2006

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The Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. **18-0350** of any fees associated with this communication.

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espectfully submitted

Attorney for Applicants

Lawrence E. Ashery, Reg. 34,5

March 27, 2006

Deborah Spratt

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UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO:

6,983,538 B2

Page 1 of 1

APPLICATION NO.:

10/696,598

DATED:

**JANUARY 10, 2006** 

INVENTOR(S):

MASAFUMI INOUE ET AL.

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

### Column 6

Lines 21-49, claims 4-7, delete

- "4. A method of mounting components on a board, said method comprising the steps of:
- a) receiving mounting locations of where said components are intended to be mounted on said board,
  - b) determining where solder for said components is situated on said board,
- c) determining where said components are to be mounted on said board based on steps a) and b); and
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- 5. A method of mounting components according to claim 4, wherein step c) includes the step of modifying said mounting locations based on step b), wherein said components are mounted in step d) based on said modified mounting locations.
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- a memory in which is situated location values which correspond to where components are intended to be mounted on said board;
- a locator for identifying solder locations which correspond to respective locations of solder on said board;
- a mounter for mounting said components based on said location values and said solder locations.
- 7. Apparatus for mounting components according to claim 6, further comprising a calculation unit which modifies said location values based on said solder values, wherein said mounter mounts said components based on said modified location values."

Mailing Address of Sender:

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# UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO:

6,983,538 B2

Page 1 of 1

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10/696,598

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#### Column 6

Lines 21-49, claims 4-7, delete

- "4. A method of mounting components on a board, said method comprising the steps of:
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- 7. Apparatus for mounting components according to claim 6, further comprising a calculation unit which modifies said location values based on said solder values, wherein said mounter mounts said components based on said modified location values."

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